

LOC		DIST		REVISIONS			
AD		00		REV	DESCRIPTION	DATE	DWN
				01	REV PER ECO-07-015274	27JUN2007	BC

- 1

HOUSING : POLYESTER, GRAY.
CONTACT: HIGH CURRENT COPPER ALLOY.
- 2

CONTACT MATING AREA: 1.27μm MIN GOLD PLATE,
ACTION PIN AREA, 0.5μm MIN TIN-LEAD PLATE,
ALL OVER 1.27μm MIN NICKEL UNDERPLATE.
- 3

DIMENSION APPLIES AFTER CONNECTOR IS APPLIED TO PC BOARD.
- 4

DATE CODE THIS APPROXIMATE AREA, OPPOSITE SIDE.
- 5

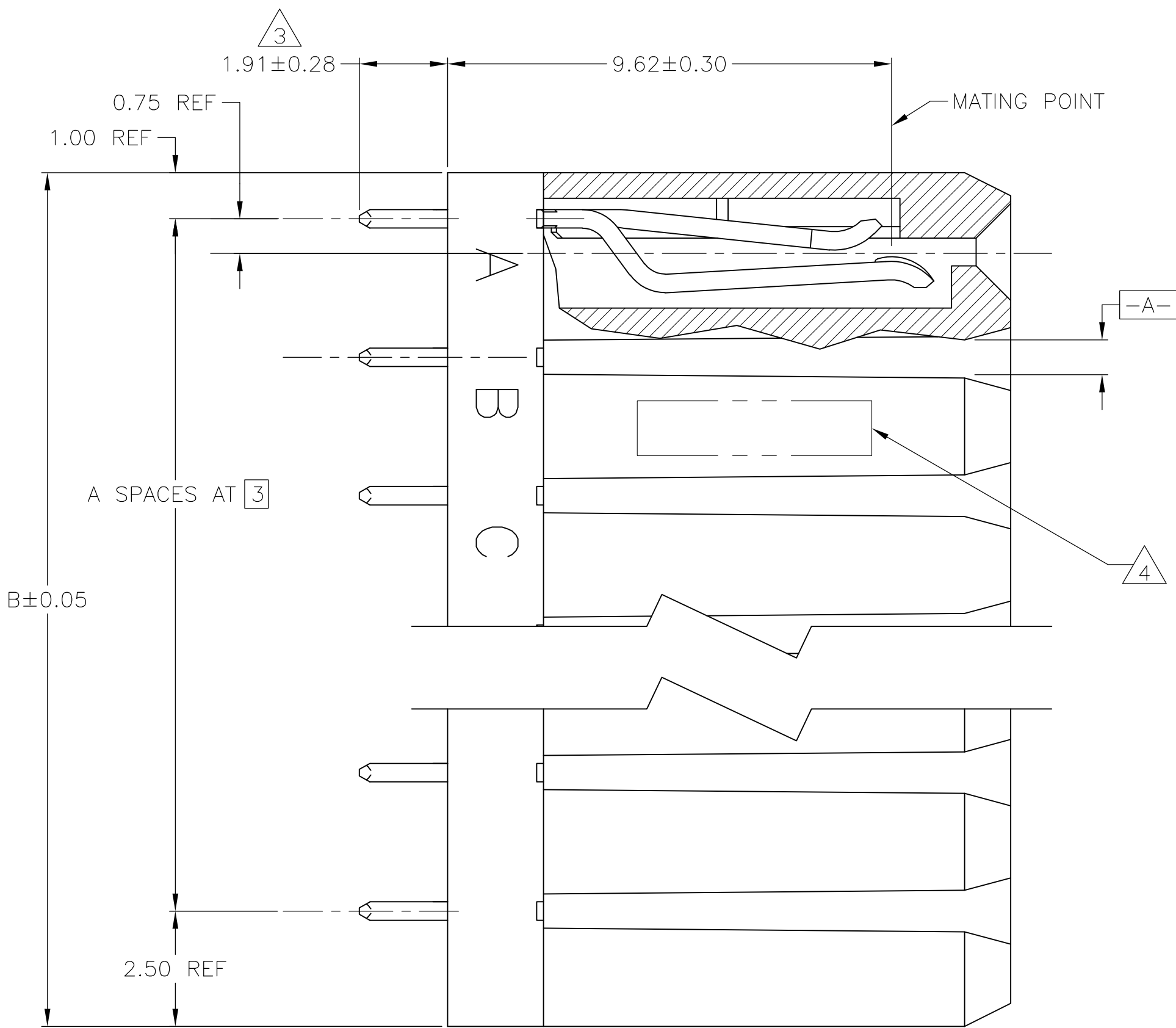
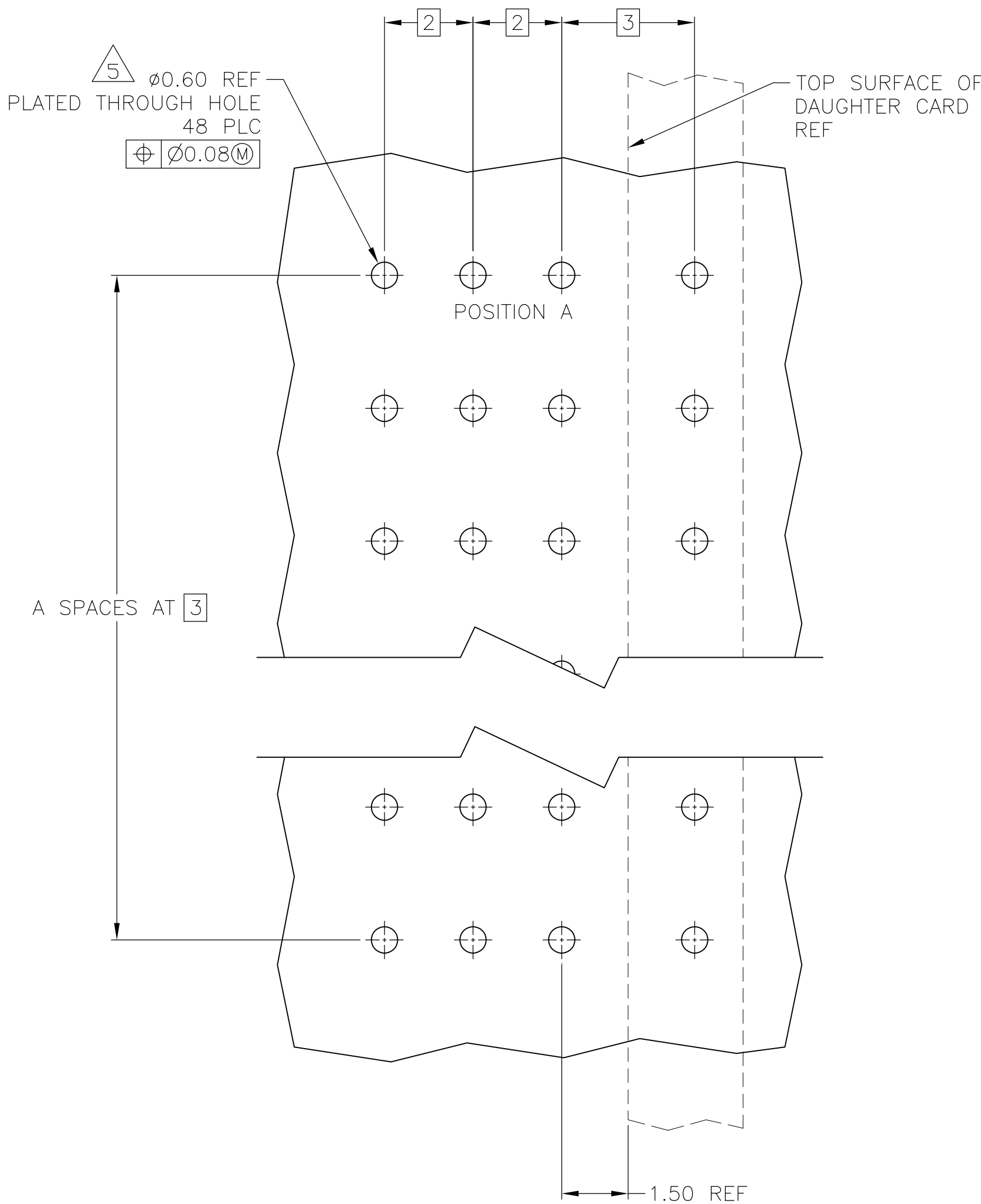
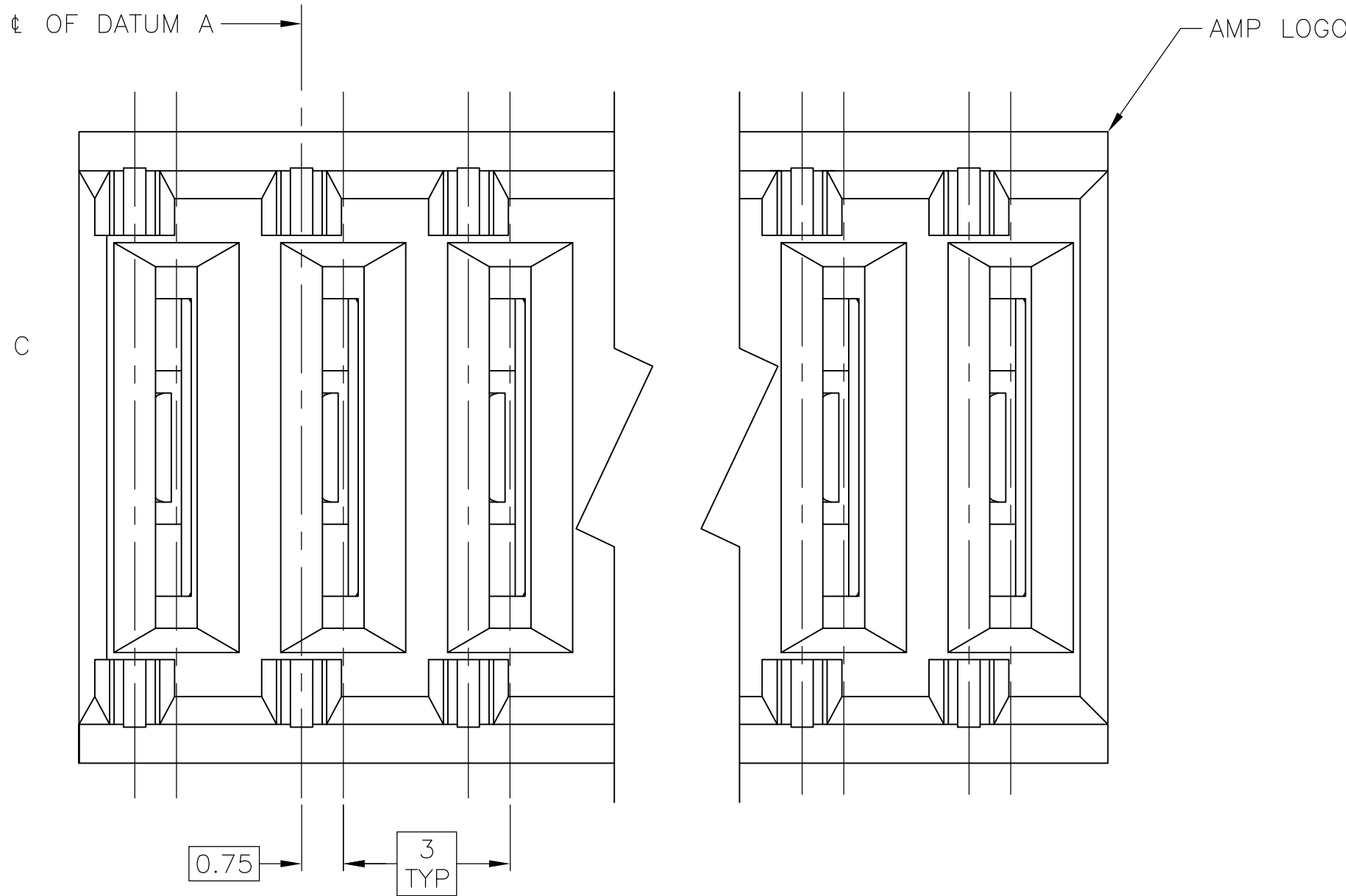
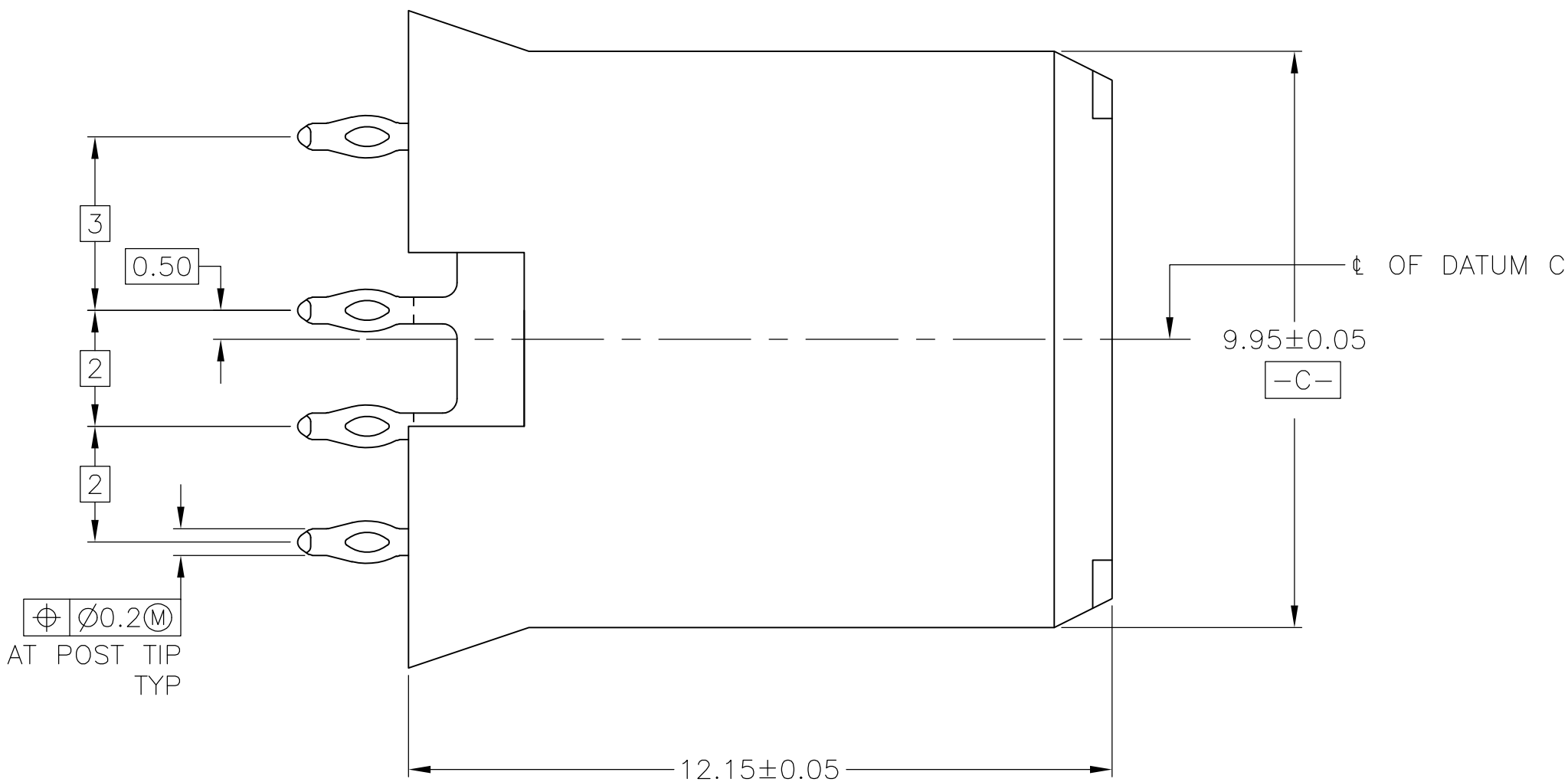
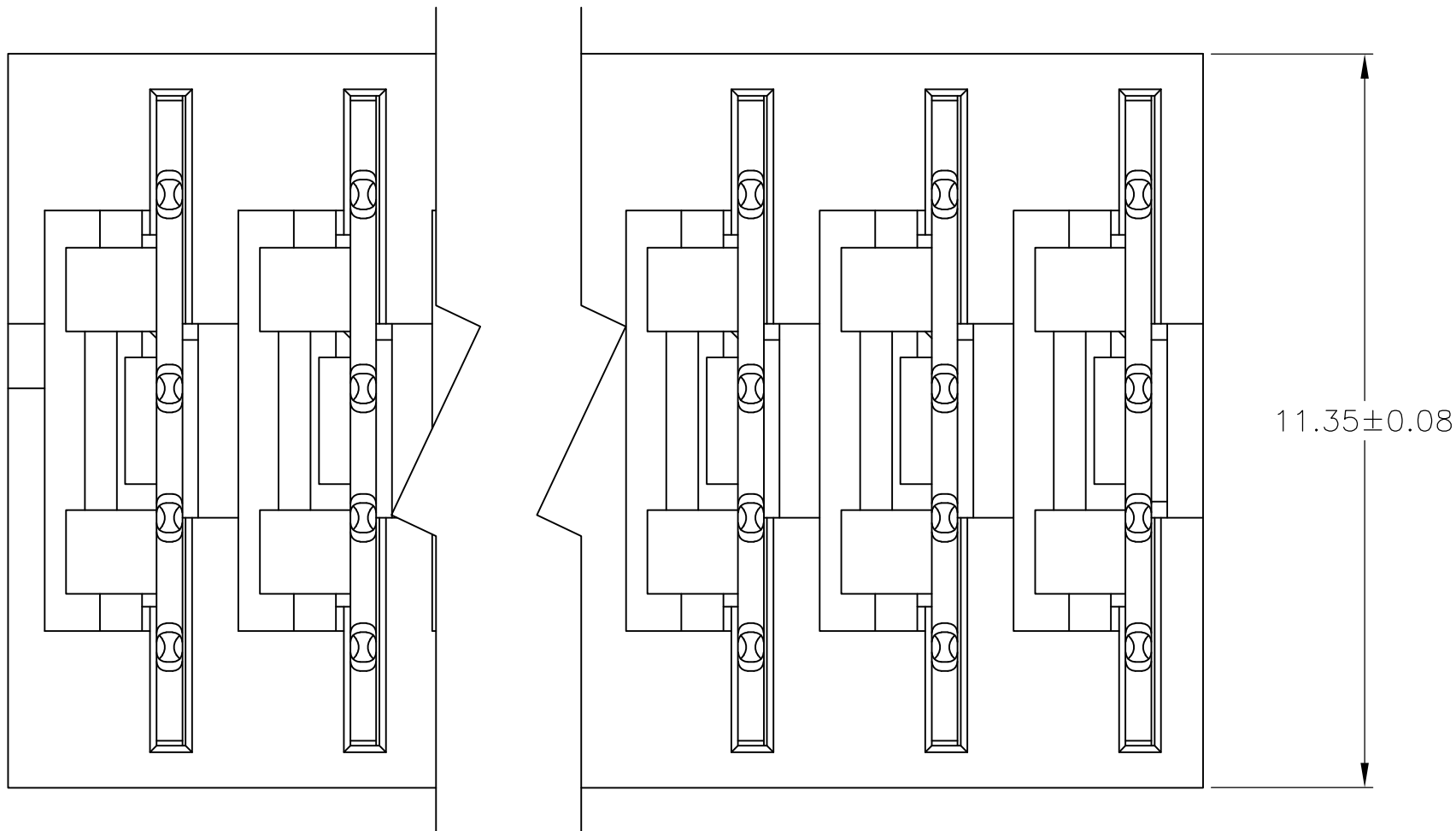
REFERENCE APPLICATION SPEC 114-1103 FOR RECOMMENDED PLATED
THRU HOLE DIAMETER AND PLATING THICKNESSES.

D

C

B

A



RECOMMENDED PCB HOLE LAYOUT

12	36.5	11	1-120950-0
11	33.5	10	120950-9
10	30.5	9	120950-8
9	27.5	8	120950-7
8	24.5	7	120950-6
7	21.5	6	120950-5
6	18.5	5	120950-4
5	15.5	4	120950-3
4	12.5	3	120950-2
3	9.5	2	120950-1
POSITION		B	A
		PART NUMBER	

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN B CARBO	29JUL04	Tyco Electronics Corporation Harrisburg, PA 17105-3608	
DIMENSIONS: mm		CHK R PATTERSON	12/9/99	NAME R PATTERSON	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD R PATTERSON	12/9/99	PRODUCT SPEC	
0 PLC ± -		APPLICATION SPEC		SIZE	
1 PLC ± -		WEIGHT		CAGE CODE	
2 PLC ± 0.13		CUSTOMER DRAWING		DRAWING NO	
3 PLC ± -		SCALE		RESTRICTED TO	
4 PLC ± -		SHEET		REV	
ANGLES ± -		10:1		1 OF 1	
FINISH		A1		00779	
MATERIAL		120950		120950	